

## Features

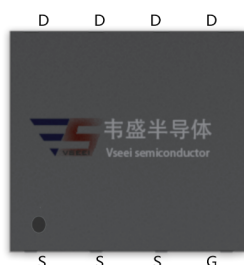
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS Tested
- 100%  $\Delta V_{DS}$  Tested
- Halogen-free; RoHS-compliant
- Pb-free plating

## Applications

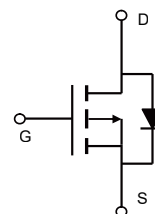
- Load Switch
- PWM Application
- Power Management

## Product Summary

| Parameters                       | Value | Unit       |
|----------------------------------|-------|------------|
| $V_{DSS}$                        | -100  | V          |
| $V_{GS(th\_Typ)}$                | -1.7  | V          |
| $I_D(@V_{GS}=-10V)$              | -17   | A          |
| $R_{DS(ON\_Typ)}(@V_{GS}=-10V)$  | 39    | m $\Omega$ |
| $R_{DS(ON\_Typ)}(@V_{GS}=-4.5V)$ | 51    | m $\Omega$ |



DFN3x3



Schematic

## Ordering Information

| Device       | Marking  | MSL | Form      | Package | Reel(pcs) | Per Carton (pcs) |
|--------------|----------|-----|-----------|---------|-----------|------------------|
| VSM17P10-D33 | VSM17P10 | 1   | Tape&Reel | DFN3x3  | 5000      | 50000            |

## Absolute Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

| Symbol         | Parameter                                     | Value                                                 | Unit             |
|----------------|-----------------------------------------------|-------------------------------------------------------|------------------|
| $V_{DS}$       | Drain-to-Source Voltage                       | -100                                                  | V                |
| $V_{GS}$       | Gate-to-Source Voltage                        | $\pm 20$                                              | V                |
| $I_D$          | Continuous Drain Current                      | $T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$ | A                |
| $I_{DM}$       | Pulsed Drain Current <sup>(1)</sup>           | Refer to Fig.4                                        | A                |
| $E_{AS}$       | Single Pulsed Avalanche Energy <sup>(2)</sup> | 165                                                   | mJ               |
| $P_D$          | Power Dissipation                             | $T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$ | W                |
| $T_J, T_{STG}$ | Junction & Storage Temperature Range          | -55 to 150                                            | $^\circ\text{C}$ |

## Thermal Characteristics

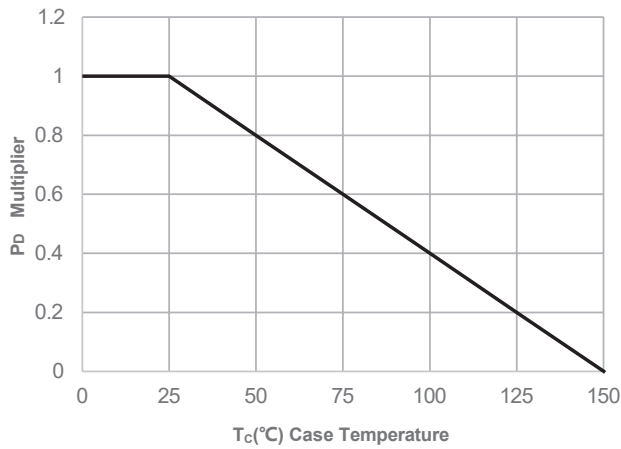
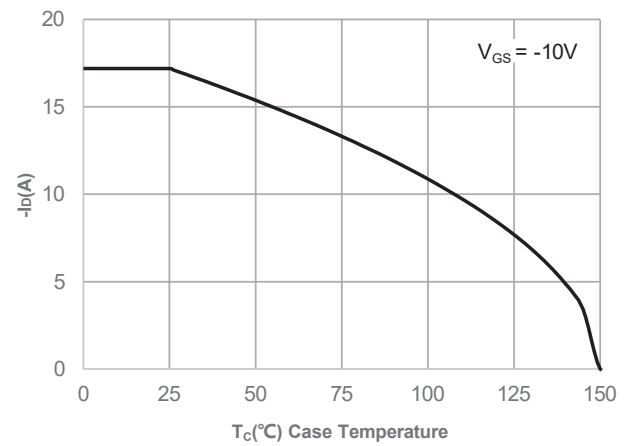
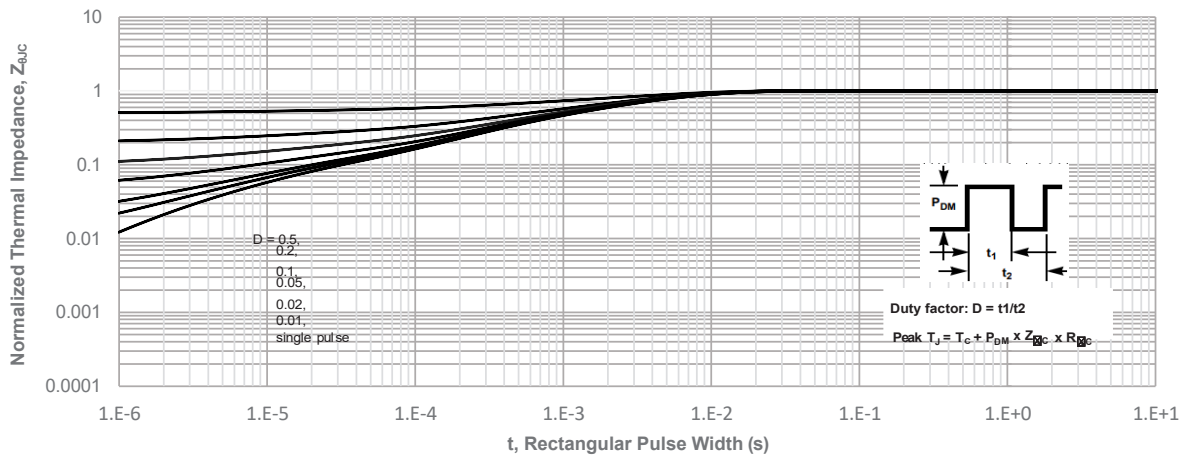
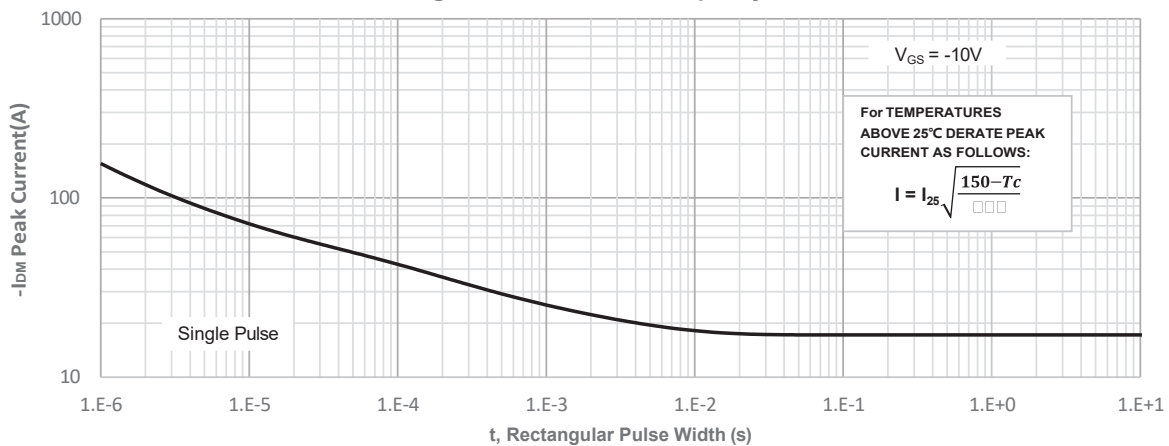
| Symbol          | Parameter                                              | Max | Unit               |
|-----------------|--------------------------------------------------------|-----|--------------------|
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient <sup>(3)</sup> | 48  | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case                   | 4.2 | $^\circ\text{C/W}$ |

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

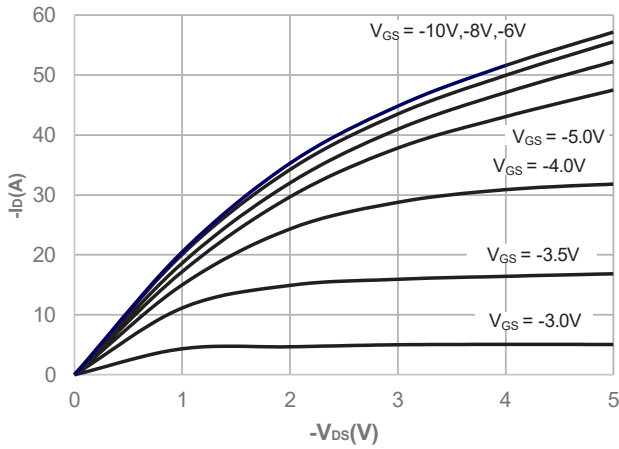
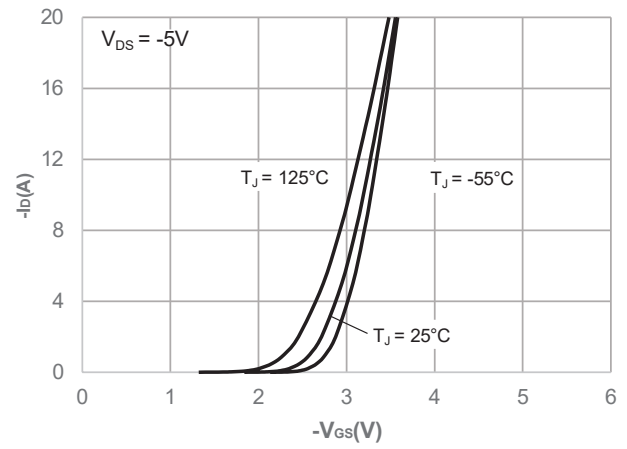
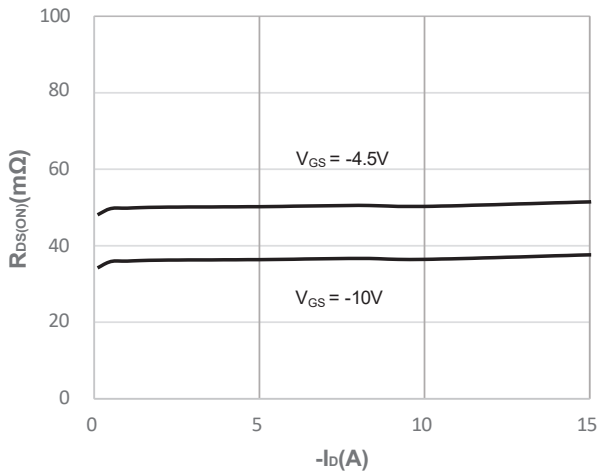
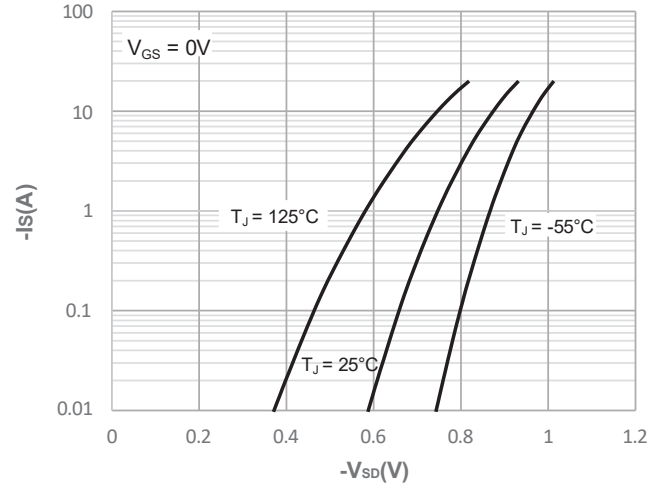
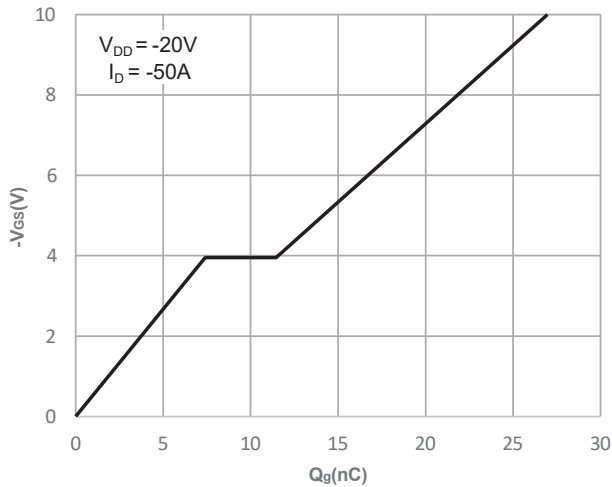
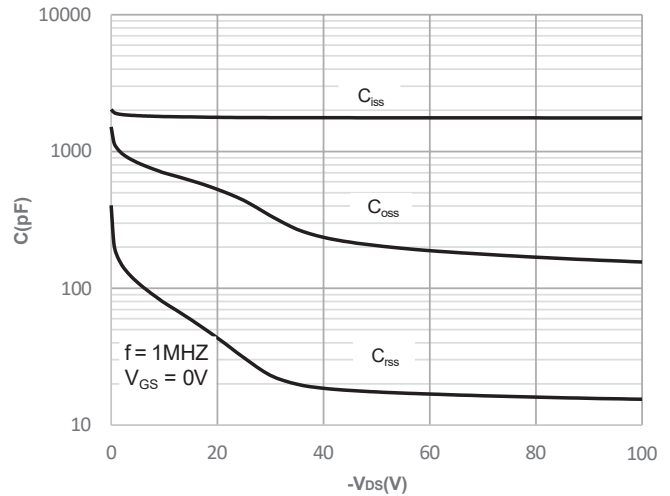
| Symbol                     | Parameter                                        | Conditions                                                                                      | Min. | Typ. | Max. | Unit |
|----------------------------|--------------------------------------------------|-------------------------------------------------------------------------------------------------|------|------|------|------|
| Off Characteristics        |                                                  |                                                                                                 |      |      |      |      |
| V <sub>(BR)DSS</sub>       | Drain-Source Breakdown Voltage                   | I <sub>D</sub> = -250 μA, V <sub>GS</sub> = 0V                                                  | -100 | -    | -    | V    |
| I <sub>DSS</sub>           | Zero Gate Voltage Drain Current                  | V <sub>DS</sub> = -80V, V <sub>GS</sub> = 0V                                                    | -    | -    | -1.0 | μA   |
| I <sub>GSS</sub>           | Gate-Body Leakage Current                        | V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V                                                    | -    | -    | ±100 | nA   |
| On Characteristics         |                                                  |                                                                                                 |      |      |      |      |
| V <sub>GS(th)</sub>        | Gate Threshold Voltage                           | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA                                    | -1.2 | -1.7 | -2.2 | V    |
| R <sub>DS(ON)</sub>        | Static Drain-Source ON-Resistance <sup>(4)</sup> | V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A                                                   | -    | 39   | 51   | mΩ   |
|                            |                                                  | V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -15A                                                  | -    | 51   | 67   | mΩ   |
| Dynamic Characteristics    |                                                  |                                                                                                 |      |      |      |      |
| R <sub>g</sub>             | Gate Resistance                                  | f = 1MHz                                                                                        | -    | 7.5  | -    | Ω    |
| C <sub>iss</sub>           | Input Capacitance                                | V <sub>GS</sub> = 0V, V <sub>DS</sub> = -50V, f = 1MHz                                          | 1261 | 1765 | 2383 | pF   |
| C <sub>oss</sub>           | Output Capacitance                               |                                                                                                 | 147  | 205  | 277  | pF   |
| C <sub>rss</sub>           | Reverse Transfer Capacitance                     |                                                                                                 | 12   | 17   | 24   | pF   |
| Q <sub>g</sub>             | Total Gate Charge                                | V <sub>GS</sub> = 0 to -10V<br>V <sub>DS</sub> = -50V, I <sub>D</sub> = -20A                    | 19   | 27   | 36   | nC   |
| Q <sub>gs</sub>            | Gate Source Charge                               |                                                                                                 | -    | 7.4  | -    | nC   |
| Q <sub>gd</sub>            | Gate Drain("Miller") Charge                      |                                                                                                 | -    | 4.1  | -    | nC   |
|                            |                                                  |                                                                                                 |      |      |      |      |
| Switching Characteristics  |                                                  |                                                                                                 |      |      |      |      |
| t <sub>d(on)</sub>         | Turn-On DelayTime                                | V <sub>GS</sub> = -10V, V <sub>DD</sub> = -50V<br>I <sub>D</sub> = -20A, R <sub>GEN</sub> = 3 Ω | -    | 7    | -    | ns   |
| t <sub>r</sub>             | Turn-On Rise Time                                |                                                                                                 | -    | 6.5  | -    | ns   |
| t <sub>d(off)</sub>        | Turn-Off DelayTime                               |                                                                                                 | -    | 38   | -    | ns   |
| t <sub>f</sub>             | Turn-Off Fall Time                               |                                                                                                 | -    | 9.4  | -    | ns   |
| Body Diode Characteristics |                                                  |                                                                                                 |      |      |      |      |
| I <sub>S</sub>             | Maximum Continuous Body Diode Forward Current    |                                                                                                 | -    | -    | -17  | A    |
| I <sub>SM</sub>            | Maximum Pulsed Body Diode Forward Current        |                                                                                                 | -    | -    | -69  | A    |
| V <sub>SD</sub>            | Body Diode Forward Voltage                       | V <sub>GS</sub> = 0V, I <sub>S</sub> = -20A                                                     | -    |      | -1.2 | V    |
| trr                        | Body Diode Reverse Recovery Time                 | I <sub>F</sub> = -20A, di/dt = 100A/us                                                          | 35   | 49   | 67   | ns   |
| Qrr                        | Body Diode Reverse Recovery Charge               |                                                                                                 | -    | 128  | -    | nC   |

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
  2.  $E_{AS}$  condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = -50\text{V}$ ,  $V_{GS} = -10\text{V}$ ,  $R_G = 25\ \Omega$ ,  $L = 3\text{mH}$ ,  $I_{AS} = -10.5\text{A}$ ,  $V_{DD} = 0\text{V}$  during time in avalanche.
  3.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB.
  4. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Typical Performance Characteristics

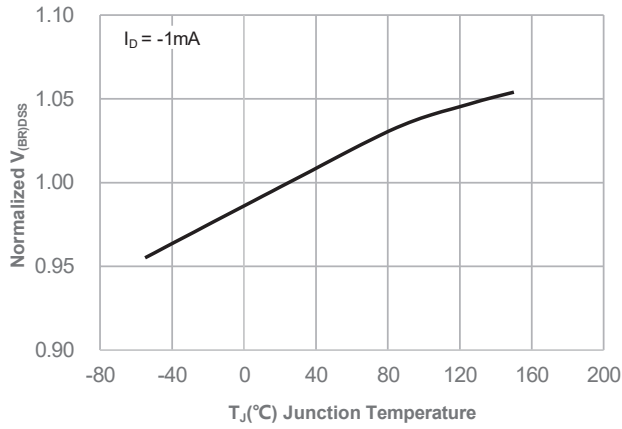
**Figure 1: Power De-rating**

**Figure 2: Current De-rating**

**Figure 3: Normalized Maximum Transient Thermal Impedance**

**Figure 4: Peak Current Capacity**


## Typical Performance Characteristics

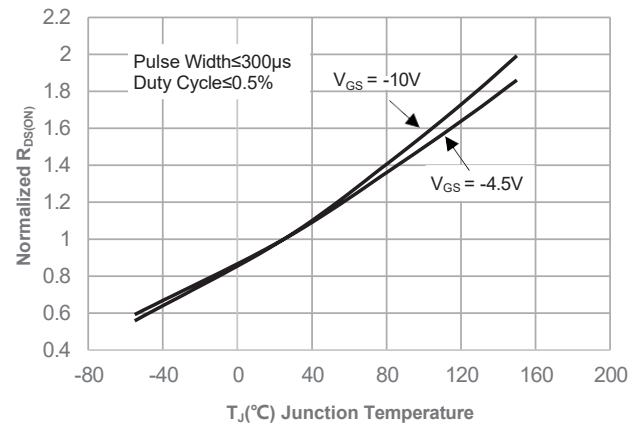
**Figure 5: Output Characteristics**

**Figure 6: Typical Transfer Characteristics**

**Figure 7: On-resistance vs. Drain Current**

**Figure 8: Body Diode Characteristics**

**Figure 9: Gate Charge Characteristics**

**Figure 10: Capacitance Characteristics**


## Typical Performance Characteristics

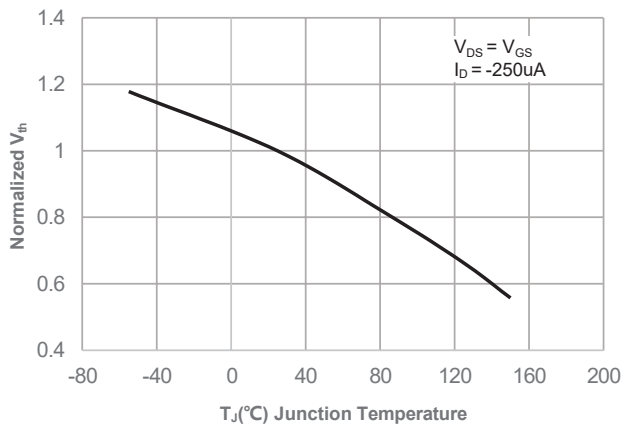
**Figure 11: Normalized Breakdown voltage vs. Junction Temperature**



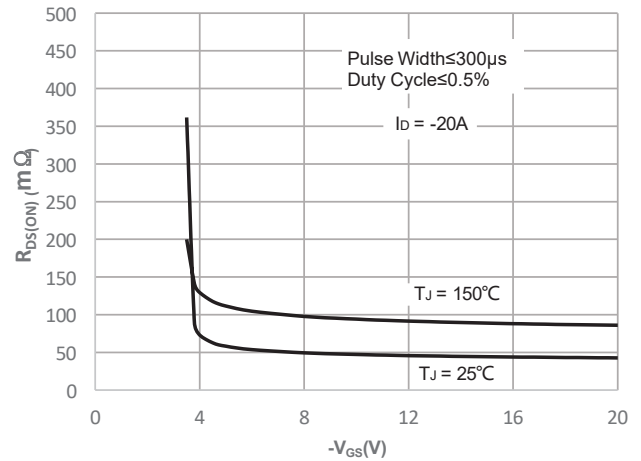
**Figure 12: Normalized on Resistance vs. Junction Temperature**



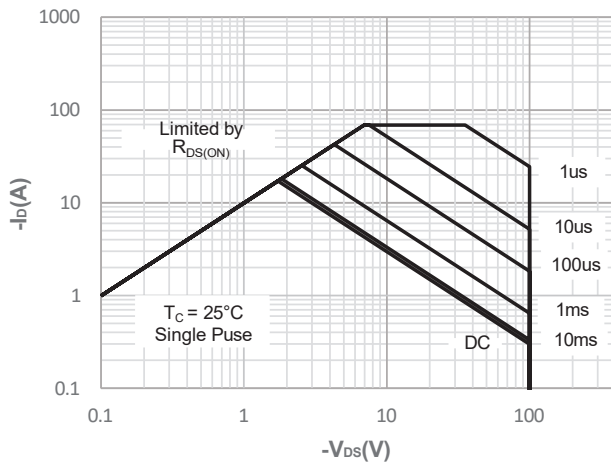
**Figure 13: Normalized Threshold Voltage vs. Junction Temperature**



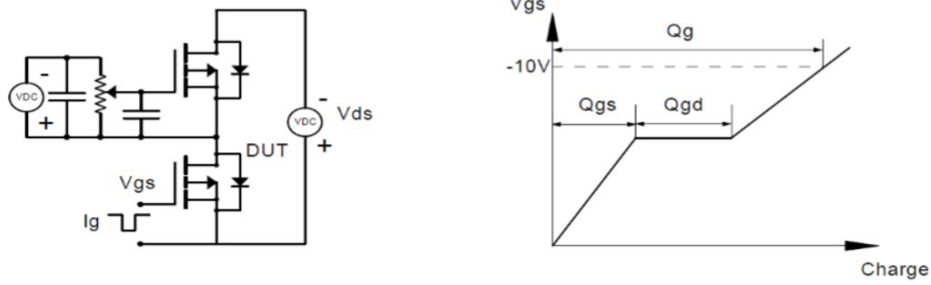
**Figure 14:  $R_{DS(ON)}$  vs.  $V_{GS}$**



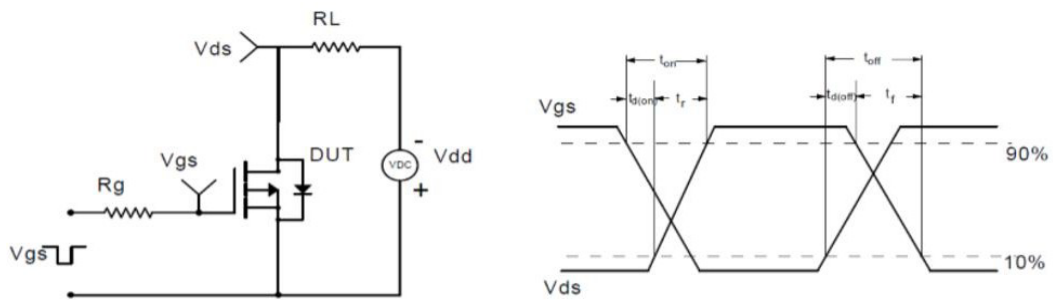
**Figure 15: Maximum Safe Operating Area**



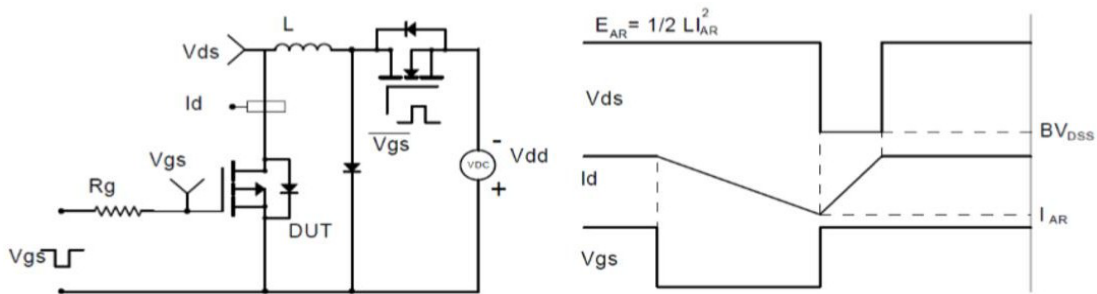
## Test Circuit



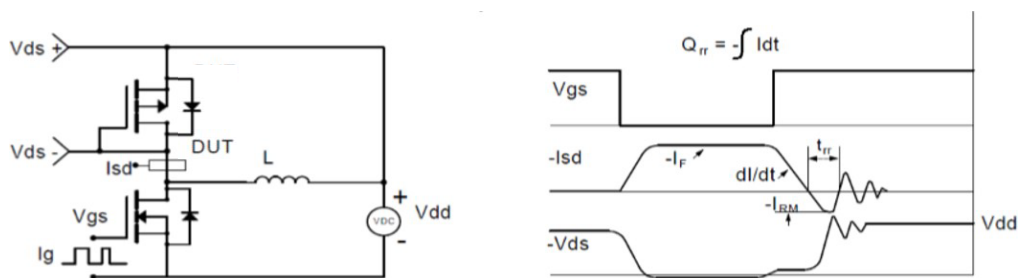
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**



**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**